



AO7801

Dual P-Channel Enhancement Mode Field Effect Transistor

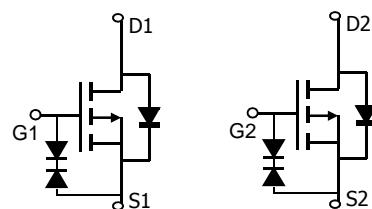
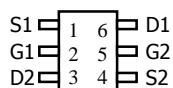
General Description

The AO7801 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge, and operation with gate voltages as low as 1.8V, in the small SOT323 footprint. It can be used for a wide variety of applications, including load switching, low current inverters and low current DC-DC converters. It is ESD protected to 2KV HBM.

Features

V_{DS} (V) = -20V
 I_D = -0.6A (V_{GS} = -4.5V)
 $R_{DS(ON)} < 520m\Omega$ (V_{GS} = -4.5V)
 $R_{DS(ON)} < 700m\Omega$ (V_{GS} = -2.5V)
 $R_{DS(ON)} < 950m\Omega$ (V_{GS} = -1.8V)

SC-70-6
(SOT-323)
Top View



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | Maximum | Units |
|--|----------------|------------|-------|
| Drain-Source Voltage | V_{DS} | -20 | V |
| Gate-Source Voltage | V_{GS} | ± 8 | V |
| Continuous Drain Current ^A | I_D | -0.6 | A |
| $T_A=70^\circ\text{C}$ | | -0.48 | |
| Pulsed Drain Current ^B | I_{DM} | -3 | |
| Power Dissipation ^A | P_D | 0.3 | W |
| $T_A=70^\circ\text{C}$ | | 0.19 | |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |

Thermal Characteristics

| Parameter | Symbol | Typ | Max | Units |
|--|-----------------|-----|-----|-------|
| Maximum Junction-to-Ambient ^A | $R_{\theta JA}$ | 360 | 415 | °C/W |
| Steady-State | | 400 | 460 | °C/W |
| Maximum Junction-to-Lead ^C | $R_{\theta JL}$ | 300 | 350 | °C/W |

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

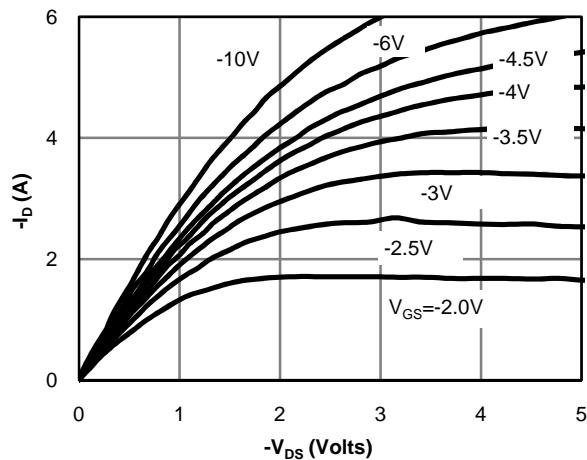


Fig 1: On-Region Characteristics

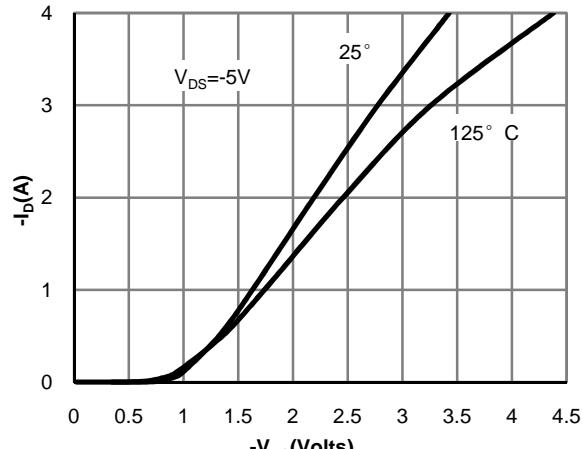


Figure 2: Transfer Characteristics

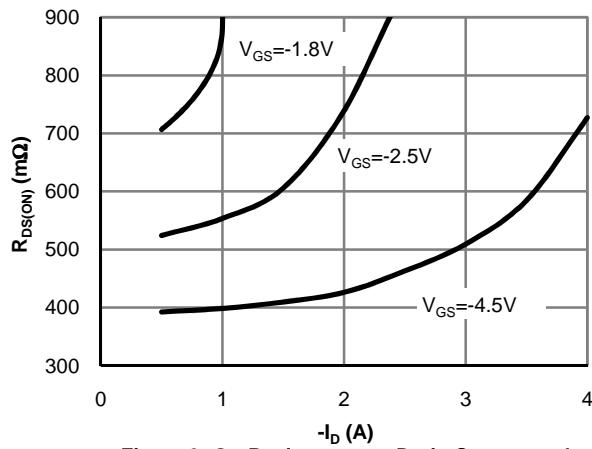


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

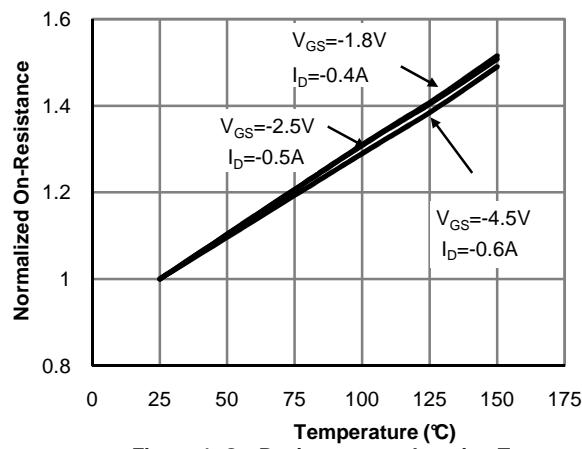


Figure 4: On-Resistance vs. Junction Temperature

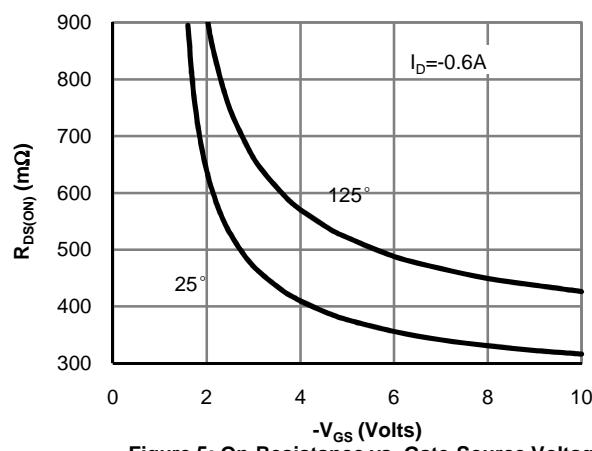


Figure 5: On-Resistance vs. Gate-Source Voltage

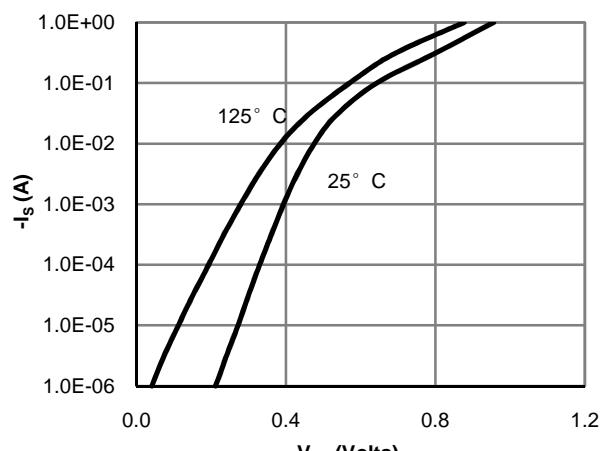


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

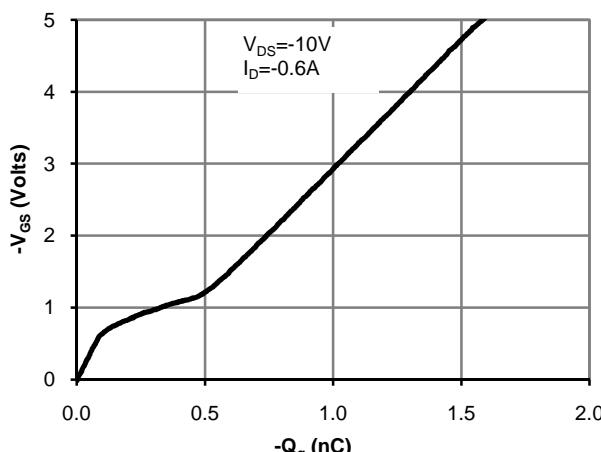


Figure 7: Gate-Charge Characteristics

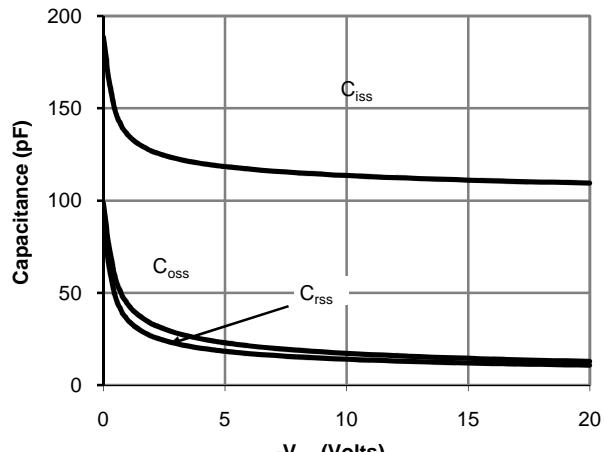


Figure 8: Capacitance Characteristics

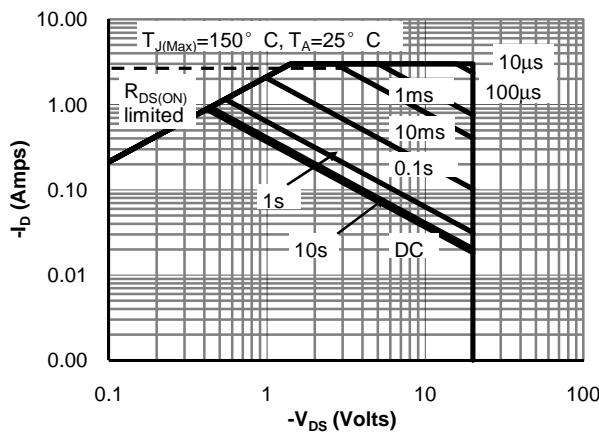


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

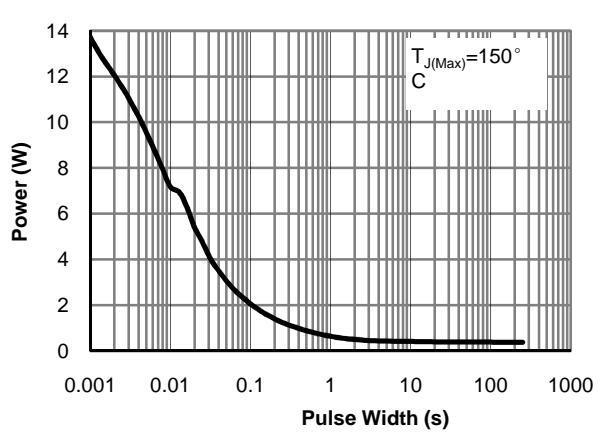


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

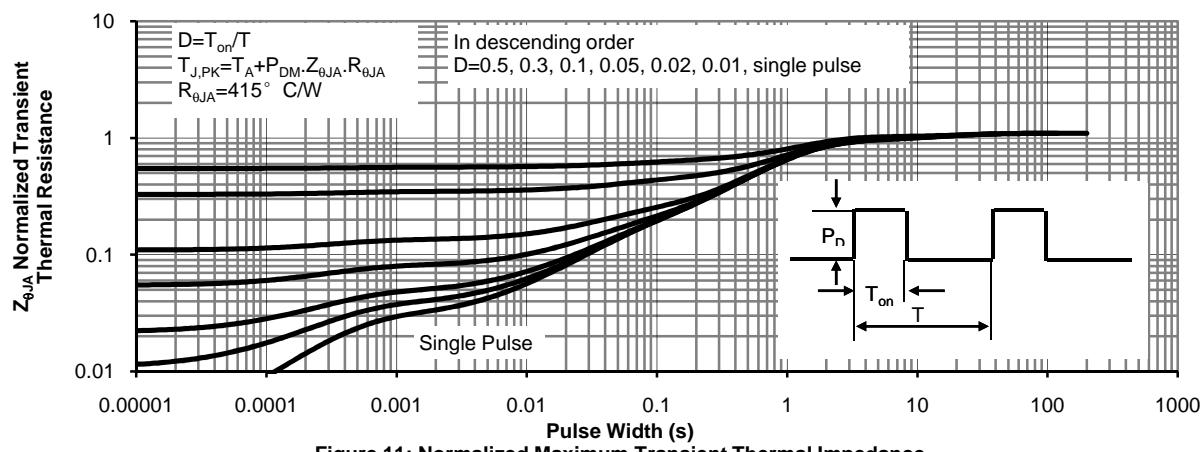


Figure 11: Normalized Maximum Transient Thermal Impedance